



MPD TPC ASSEMBLING (27.08.2025)

TPC:

- vessel assembly, ROC chambers

Sub-systems:

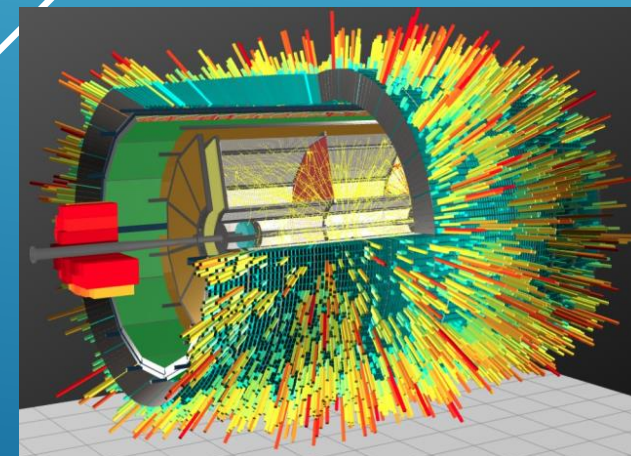
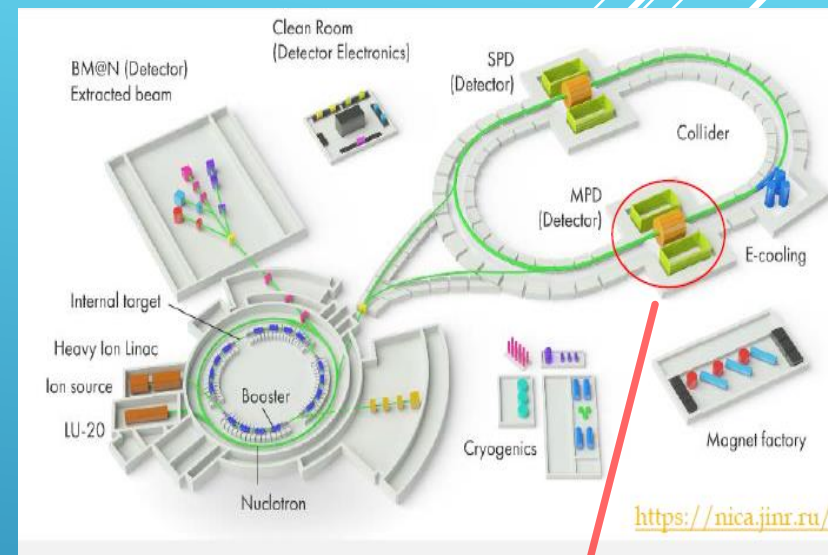
- Gating grid system
- Electronics
- LV+HV system (CAEN)
- Gas system
- Cooling system
- Laser calibration system
- Slow control

Integration of TPC to MPD

- Electronics platform
- Cabling and piping
- Installation TPC to MPD

Time schedule

TPC team – 29 (JINR) + 25 (Belarus)

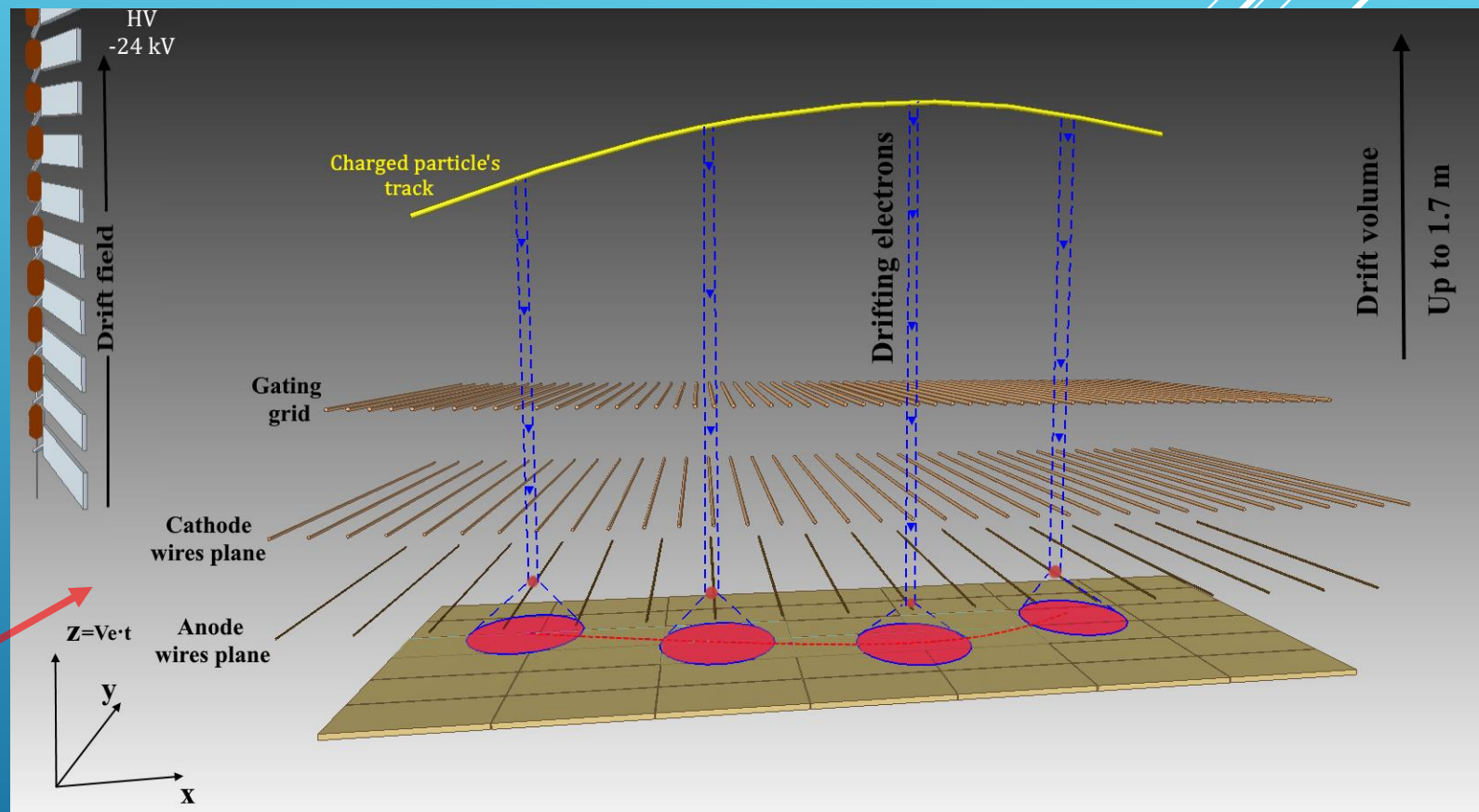
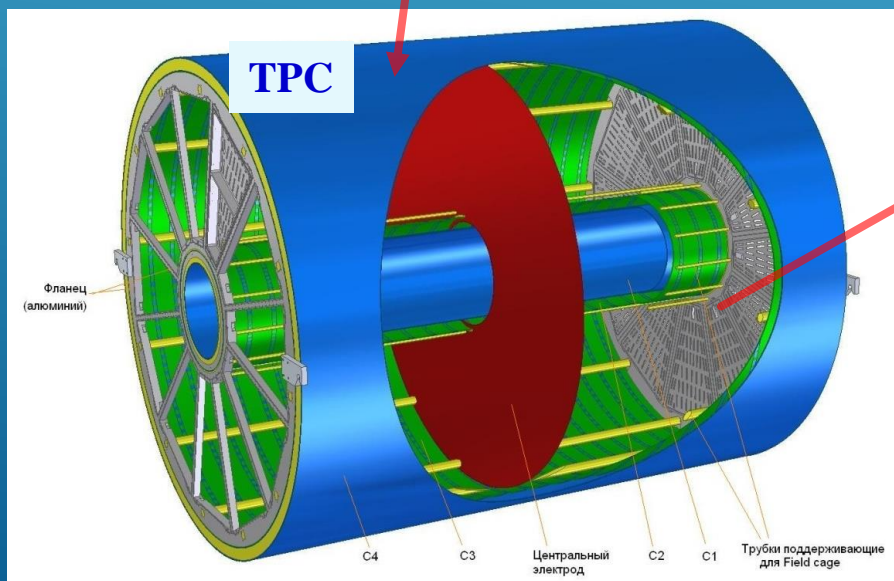
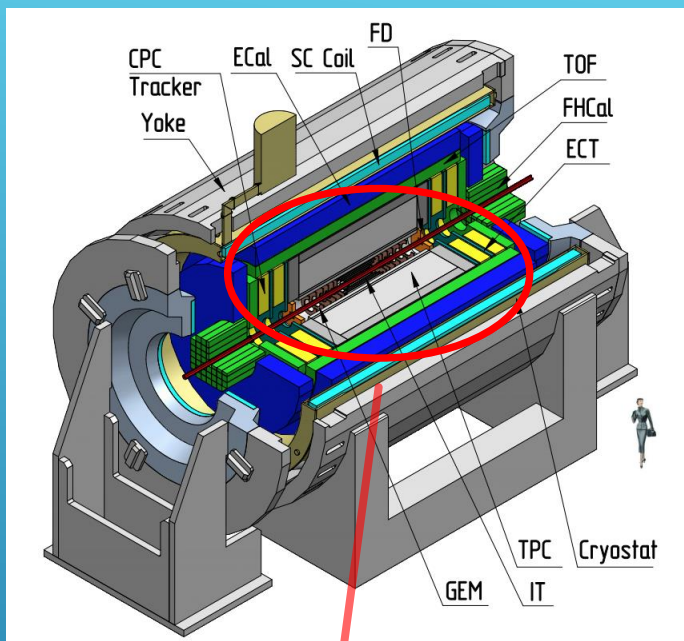


Presented by S.Movchan

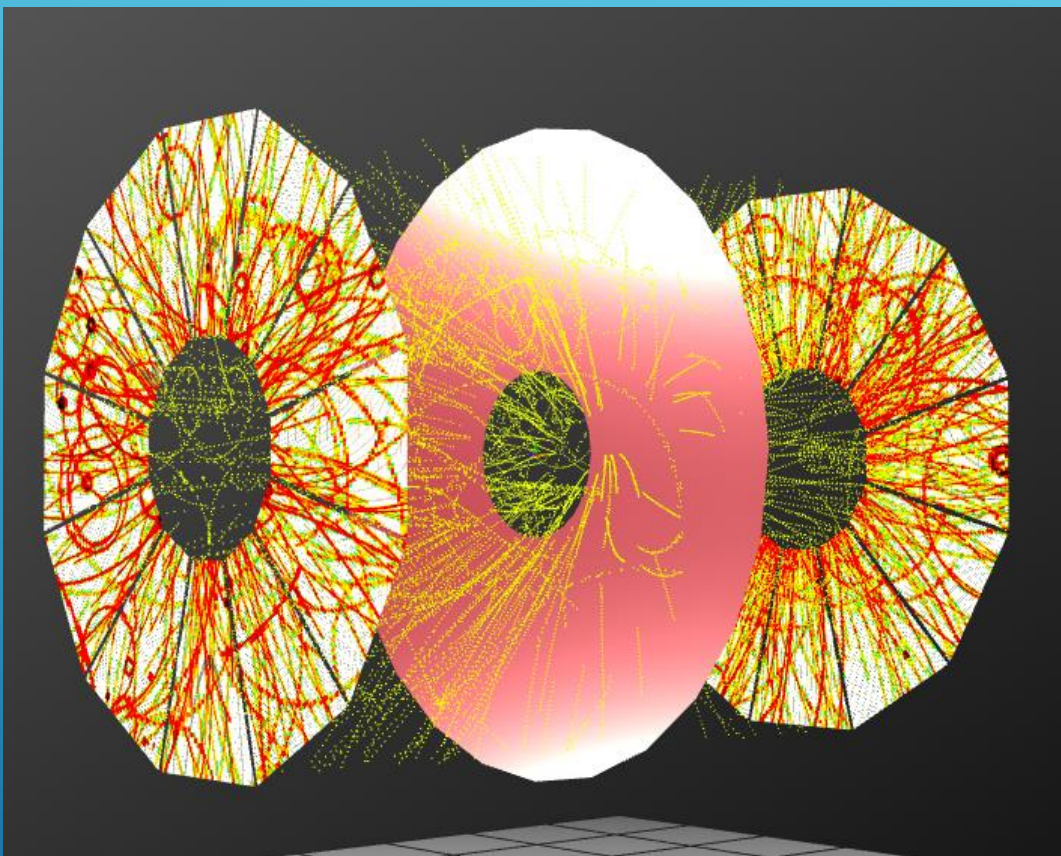
MPD concept

TPC: PRINCIPAL OF OPERATION

Read out based on MWPC

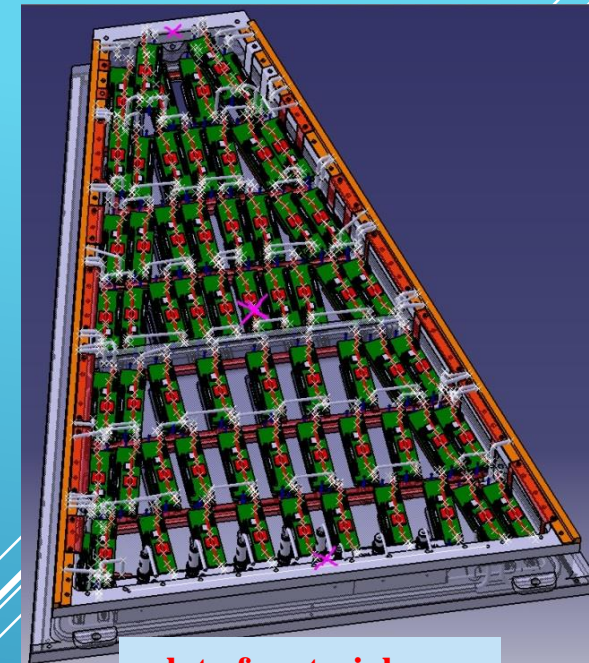


MPD TPC MAIN PARAMETERS



Item	Dimension
Length of the TPC	340cm
Outer radius of vessel	140cm
Inner radius of vessel	27 cm
Outer radius of the drift volume	133cm
Inner radius of the drift volume	34cm
Length of the drift volume	170cm (of each half)
HV electrode	Membrane at the center of the TPC
Electric field strength	~140V/cm;
Magnetic field strength	0.5 Tesla
Drift gas	90% Ar+10% Methane, Atmospheric pres. + 2 mbar
Gas amplification factor	~ 10 ⁴
Drift velocity	5.45 cm/μs;
Drift time	< 30μs;
Temperature stability	< 0.5°C
Number of readout chambers	24 (12 per each end-plate)
Segmentation in φ	30°
Pad size	5x12mm ² and 5x18mm ²
Number of pads	95232
Pad raw numbers	53
Pad numbers after zero suppression	< 10%
Maximal event rate	< 7 kHz (Lum. 10 ²⁷)
Electronics shaping time	~180 ns (FWHM)
Signal-to-noise ratio	30:1
Signal dynamical range	10 bits
Sampling rate	10 MHz
Sampling depth	310 time buckets

MPD TPC RADIATION LENGTH (BASE LINE OPTION)



- a lot of materials:**
- ROC chamber
 - Al chamber frame
 - FE electronics
 - cooling radiators
 - cables
 - pipes

END CAPS ($\eta = (1.14 \div 2.06)$):
 $X/X_0 = (47 \pm 1) \%$

BARREL ($\eta = (0 \div 1.04)$):
 $X/X_0 = (12 \pm 2.7) \%$

TPC radiation length						
	for $\eta = 0$ $\Theta = 90^\circ$	for $\eta = 1.04$ $\Theta = 38.87^\circ$ $\cos(90^\circ - 38.87^\circ) = 0.628$	for $\eta = 1.14$ $\Theta = 35.55^\circ$ $\cos(90^\circ - 35.55^\circ) = 0.581$	for $\eta = 1.51$ $\Theta = 25.03^\circ$ $\cos(90^\circ - 25.03^\circ) = 0.423$	for $\eta = 2.06$ $\Theta = 14.51^\circ$ $\cos(90^\circ - 14.51^\circ) = 0.251$	
C1 h=3 mm + Al foil:	1.061	1.689	1.826	2.508	4.227	
N ₂ (gap C1-C2) h=65 mm	0.020	0.032	0.034	0.047	0.080	
C2 h=3 mm + Al strips on C2	0.958	1.525	1.649	2.265	3.817	
TPC gas mixture L = 989 mm for $\eta = 0$	0.771	1.228 (L=1574.8 mm)	1.125 (L=1443.8 mm)	0.830 (L=1164.8 mm)	0.252 (L=322.7 mm)	
Potential degrader rods + field cage	0.085	0.135				
C3 h=4.05 mm + Al strips	1.275	2.030				
N ₂ (gap C3-C4) h=67 mm	0.020	0.032				
C4 h=6.4 mm	1.972	3.140				
TPC shielding Al, h=0.1 mm	0.112	0.178				
TPC thermal-screen (top) Al + H ₂ O, h=1.5 mm	1.043	1.686				
Air (C4 up to TOF) h = 60 mm	0.020	0.032				
Sum [C1+N2(gap C1-C2) + C2 + gas mixture]:	= 9.24	= 14.71	4.63	5.65	8.38	
ROC						
		for $\Theta = 0^\circ$	for $\Theta = 35.55^\circ$ $\cos(35.55^\circ) = 0.814$	for $\Theta = 25.03^\circ$ $\cos(25.03^\circ) = 0.906$	for $\Theta = 14.51^\circ$ $\cos(14.51^\circ) = 0.968$	
1. Wires		0.30	0.37	0.33	0.31	
2. Pad plane h=3.4 mm + inside glue		2.83	3.48	3.12	2.92	
3. Insulating plate h=3 mm		1.88	2.31	2.08	1.94	
4. Al frame h=5 mm & ROC reinforce rib + ROC cooling tube (Cu) with water		6.54 + 0.91	8.03 + 1.12	7.22 + 1.00	6.75 + 0.94	
5. Epoxy glue (2x0.1 mm)		0.056	0.069	0.062	0.058	
6. Connectors + solder		0.34	0.42	0.38	0.35	
Air gap L=100 mm		0.033	0.041	0.036	0.034	
ROC MWPC sum:		12.89	15.84	14.23	13.30	
FE (based on SAMPA chip)						
Components		0.33	0.41	0.36	0.34	
FE - (2x12 layers)x2		2.32	2.85	2.56	2.40	
Connectors + solder		0.34	0.42	0.38	0.35	
FE sum:		2.99	3.68	3.30	3.09	
FE Cooling						
Al plates on chips + Cu & Al pipes + water		7.10 + 3.68	8.72 + 4.52	7.84 + 4.06	7.33 + 3.80	
FE Cooling sum:		10.78	13.24	11.90	11.13	
LV & DAQ+SC cables + signal cables + flat cables		~ 8.82 ± 0.19	~ 8.82 ± 0.23	~ 8.82 ± 0.21	~ 8.82 ± 0.20	
Service wheel (SSW) 12.5 kG (Al) + 0.25 kG bolts		NO				
Flange C1&C2 to C3&C4 (Al) 170 kg		NO				
TPC thermal-screen Al (flange)+Al (clamps) [m(Al) = 21 kG] + H ₂ O		~1.46 ~0.01	~1.79 ~0.01	~1.61 ~0.01	~1.51 ~0.01	
Summary:	S.Movchan	TPC assembly	TPC assembly	TPC assembly	TPC assembly	TPC assembly

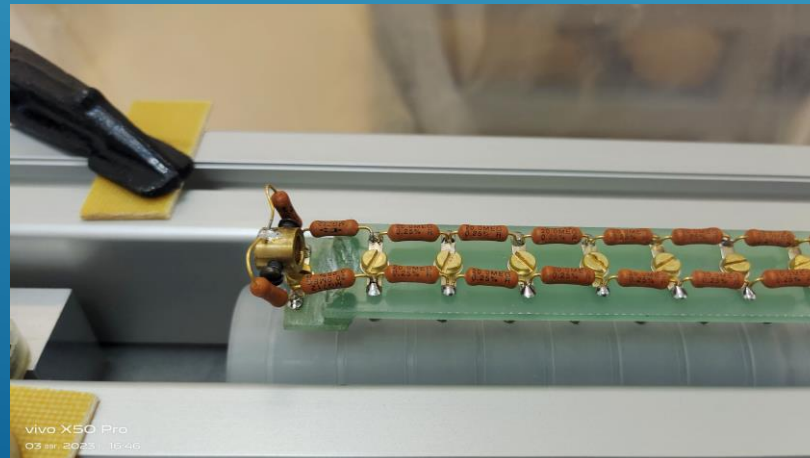
TPC VESSEL ASSEMBLING: RODs D=40 MM WITH FIELD CAGE STRIPS



Field cage HV strips



Rod with HV divider



All 24 pc RODs D=40 mm are installed
HV tested at -25 kV

TPC ROC CHAMBERS

Test setup for ROC certification



24 pc ROCs – tested



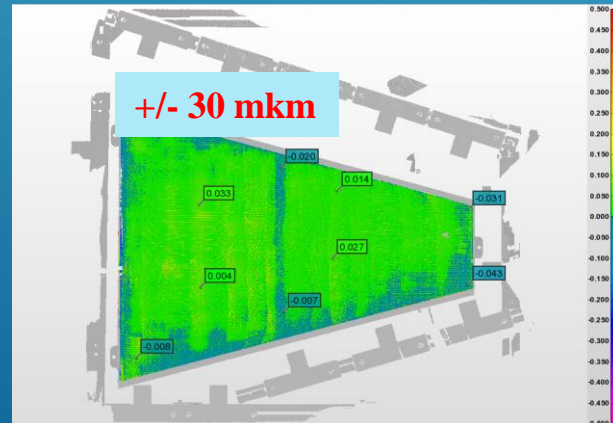
24 pc serial ROCs + 4
spare – READY!

Test setup for pads calibration

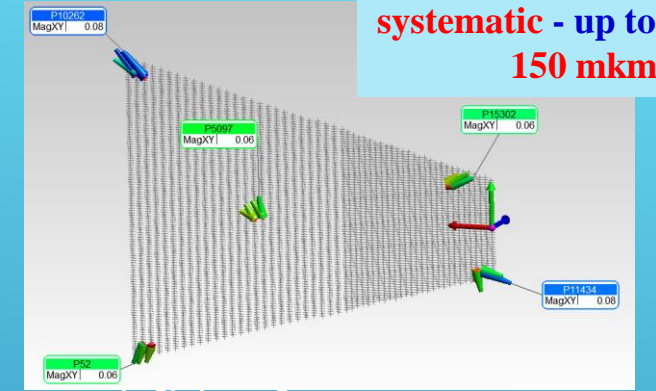


Leica MS60 - 1 second resolution
Leica AT960 +/-10 mkm +5 mkm/m
Leica AT403 +/-15 mkm +6 mkm/m
Scanner AS1+AT960 +/-50 mkm

Pad plane unflatness: example



Check pads geometry



Full set of ROC alignment marks

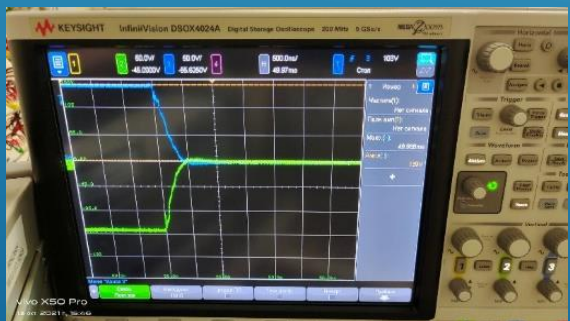


Summary:

- measurements done for all ROCs
- mapping of 3968 pads respect to ROC “reference hole” for each chamber
- in progress

TPC SUB-SYSTEMS: GATING GRID SYSTEM (GGS)

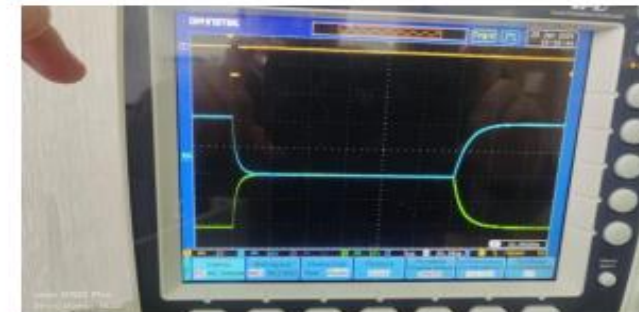
ROC gating grid system: test setup



TPC Gating grid system



4 pc NIM
crates

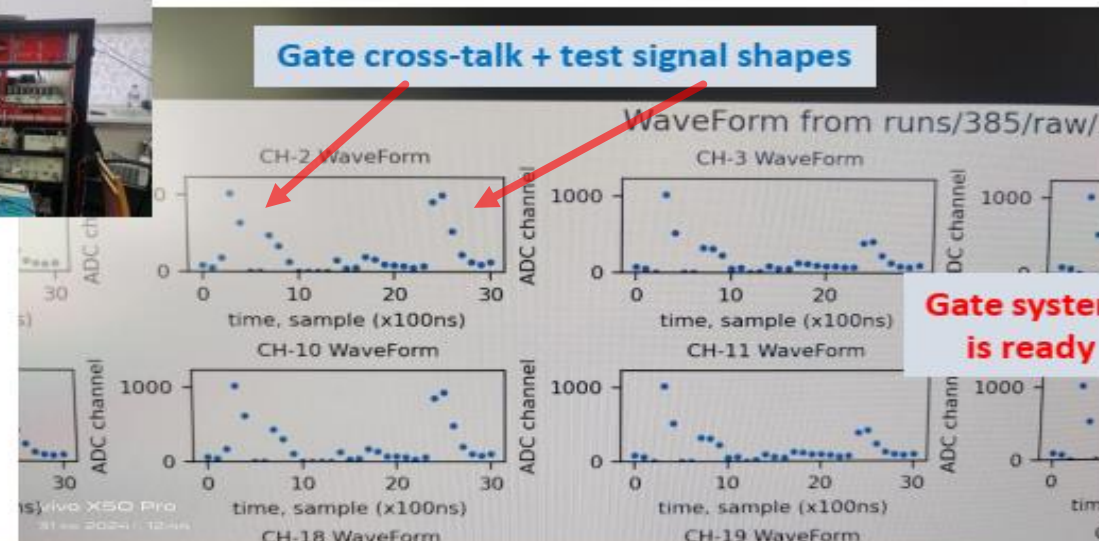


Rise time - 1 mksec
Fall time - 2 mksec

Test setup in Minsk



Gate cross-talk + test signal shapes

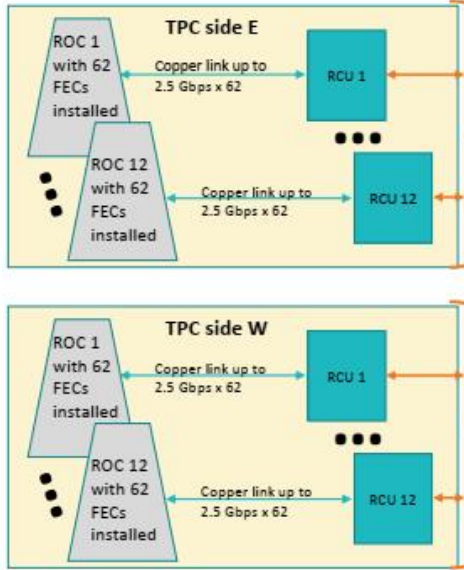


Gate cross-talk is about 1,5 microsec + test signal (500 nanosec)

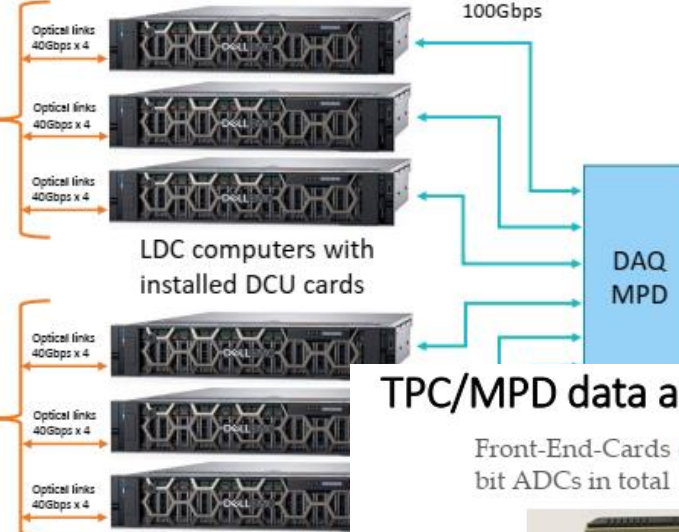
System long term test at Minsk – ongoing ...

TPC/MPD DAQ conceptual scheme

On the TPC (inside the MPD magnet)



Outside the MPD magnet



TPC/MPD data acquisition system main parts

Front-End-Cards (FEC): 1488 pc., 95 232 10-bit ADCs in total

1488 ×



Data Concentrator Units (DCU): 6 pc. in total

6 ×



Readout and Control Units (RCU): 24 pc. in total

24 ×



Local Data Concentrator (LDC) servers: 6 pc. in total

6 ×



Controller (RCU) rev 1.2– under tests ... mass-production (30pc) – Sept 2025

OK!

TPC SUB-SYSTEMS: ELECTRONICS

Readout and Control Unit (RCU)



After RCU v.1.1 testing small corrections have been done and new one is under production now.

RCU v.1.1



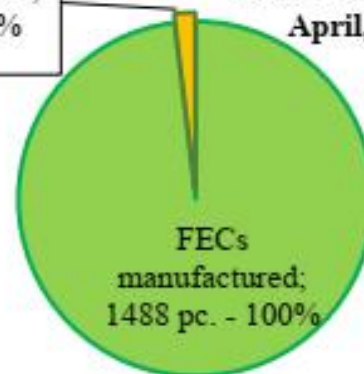
RCU v.1.2

Front-End Cards (FEC)

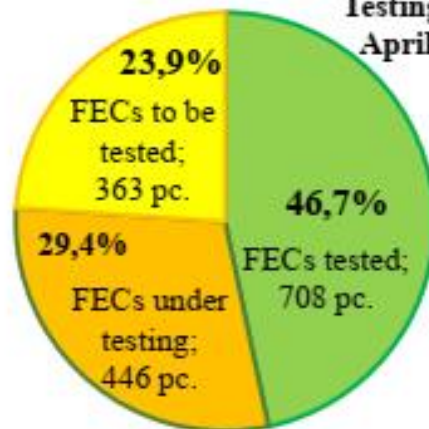


Reserve FECs;
29 pc. - 2%

TPC Front-End Cards
Production status
April, 2025



TPC Front-End Cards
Testing status
April, 2025



FEE synchronization modules

Fanout 2x8 and translation to the optical signals.
Will be installed on the MPD platform.



One ROC fanout module. Will be installed on the ROC (inside MPD magnet). On production now.

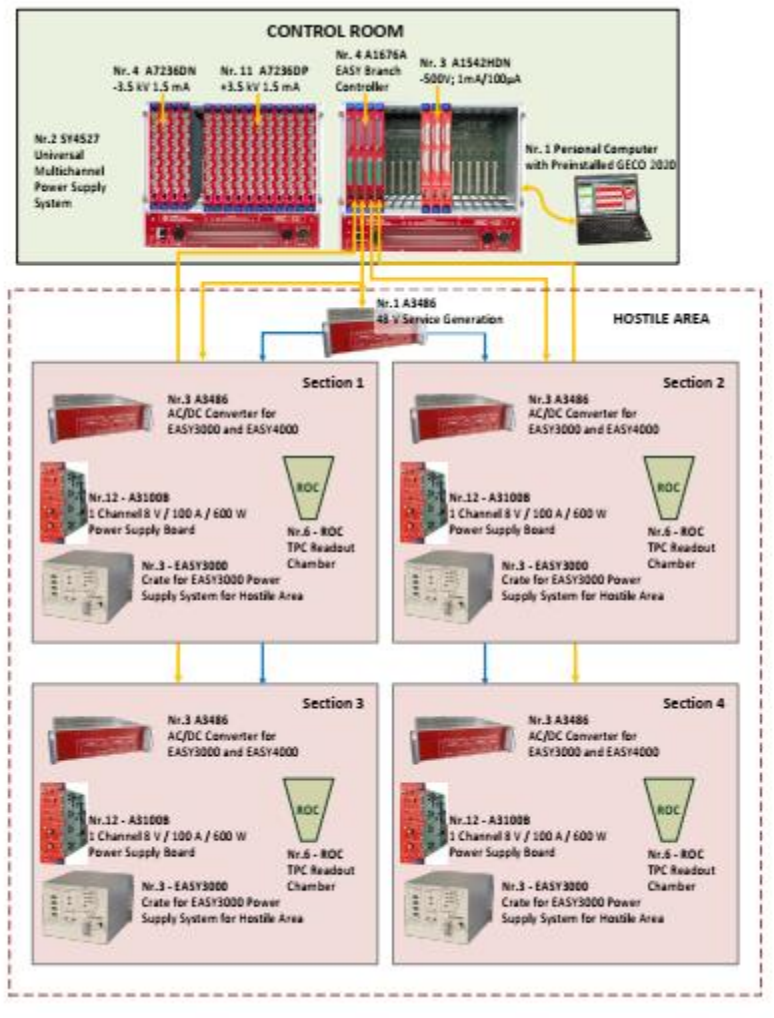


GUI software for ROC FEE control and monitoring



OK!

TPC SUB-SYSTEMS: LV+HV (CAEN)



LV&HV system based on CAEN rad. hard design:

(up to 2000 Gauss and 15 kRad)

- power converters A3486 AC/DC (380 V -> 48 V) – 15+3 pc
- EASY3000 crates – 14+2 pc
- LV module - A3100B (8V/100A) – 48+8 pc
- LV module - A3100HBP (14V/50A) – 6 +2 pc
- HV modules –A3540P (+4kV/1mA) – 8+3 pc
- HV modules –A3540N (- 4kV/1mA) – 2+2 pc

Status:

LV+HV system - **delivered**

LV cables (halogen free, low smoke, S=50 mm²) – **delivered**

HV cables – **delivered**

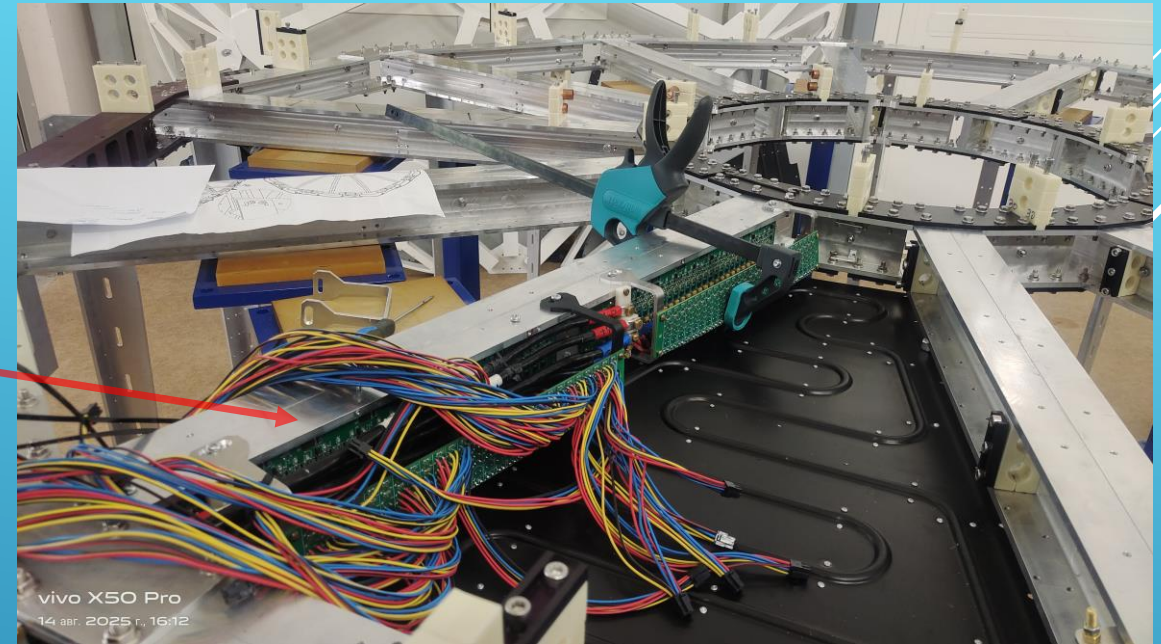
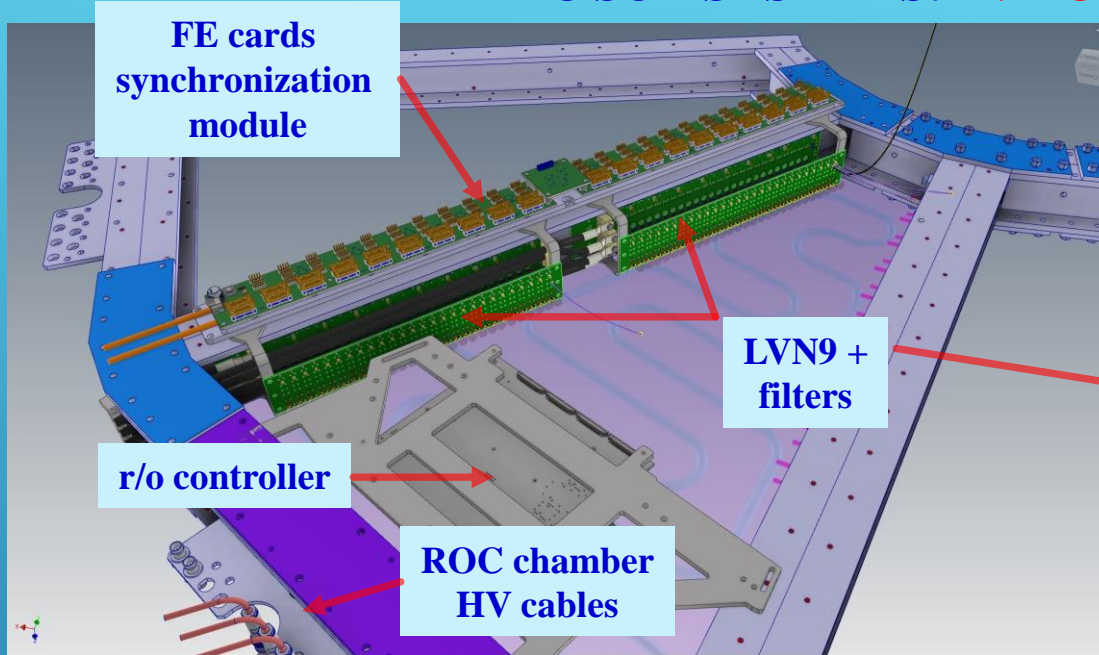


LV test setup –
tests ongoing

CAEN installation – a waiting...

Cabling:
Thermometry (~300) – Sept-Oct
LV power (~120) – Aug-Sept

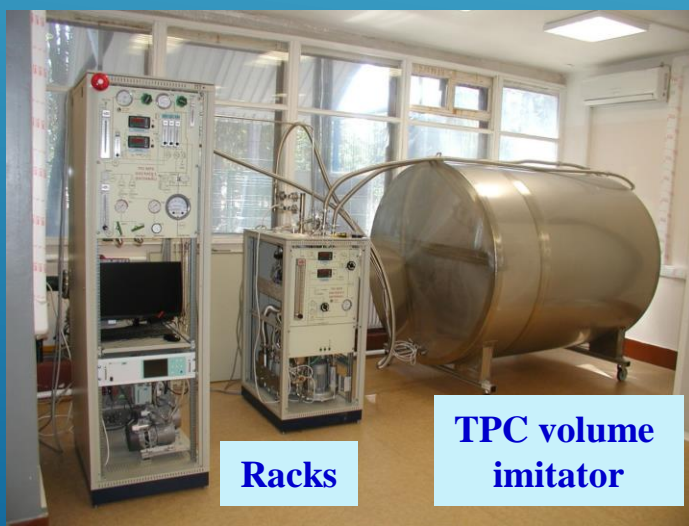
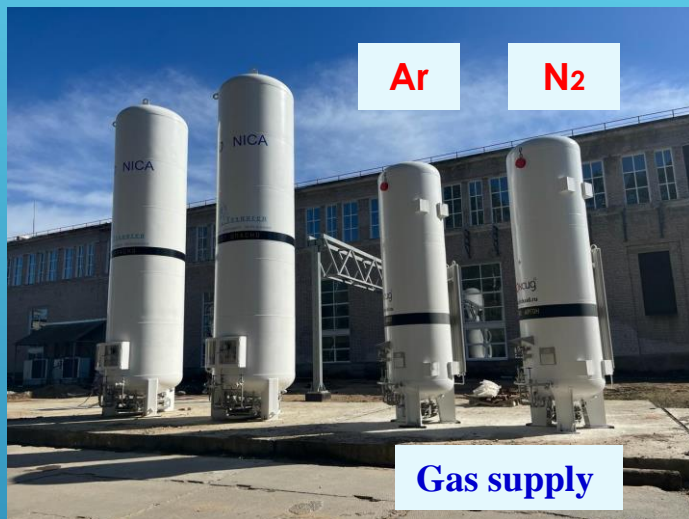
TPC SUB-SYSTEMS: LV BOARDS INTEGRATION TO SERVICE WHEEL



finished

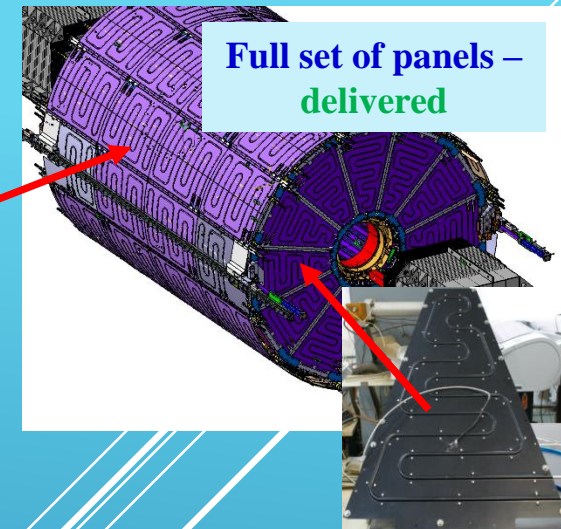
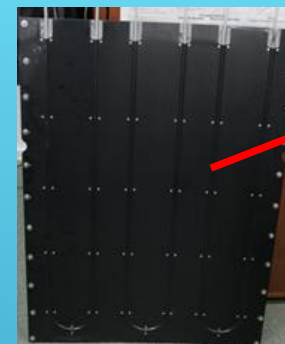
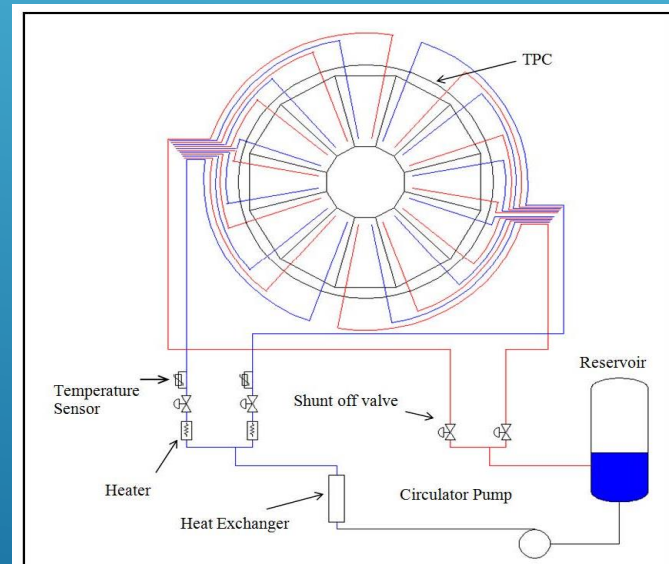
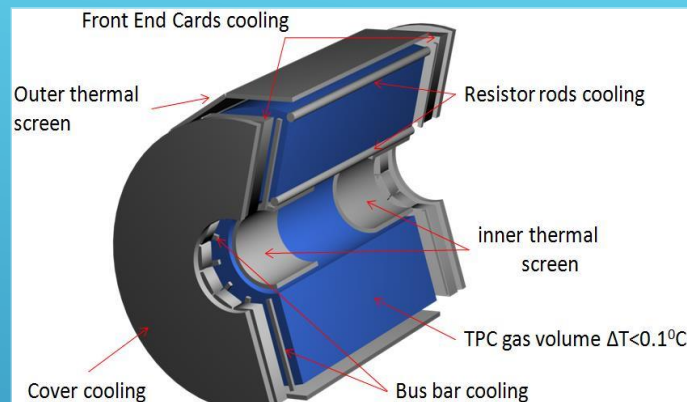
TPC SUB-SYSTEMS: GAS AND COOLING

Gas system (Ar/CH₄, 90:10)



H₂O and O₂ sensors are replaced
Tests - in progress

Water cooling system



TPC+ECAL cooling system takes 1-st, 2-nd and 3-d floors of the South platform



Contract JINR-INP BSU (Minsk) – in progress...

TPC SUB-SYSTEMS: COOLING

Assembling – in progress...



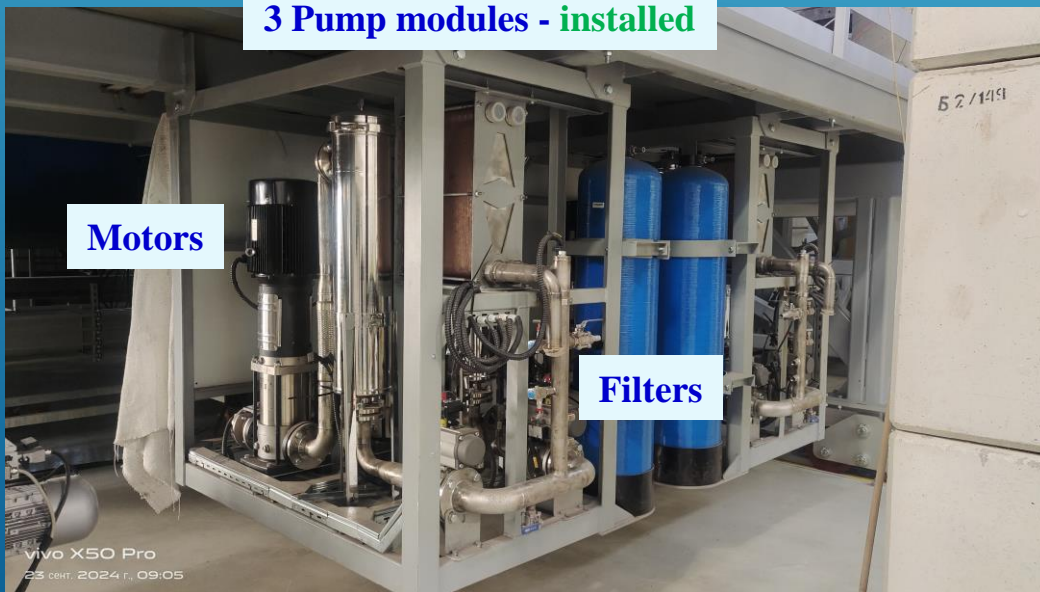
Piping - done



Connection to KOMETA cooling system -ready



3 Pump modules - installed



Motors

Filters



Assembling and cabling – in progress...

Commissioning – Dec 2025

System status - see also talk of A.Fedotov

TPC SUB-SYSTEMS: LASER CALIBRATION SYSTEM

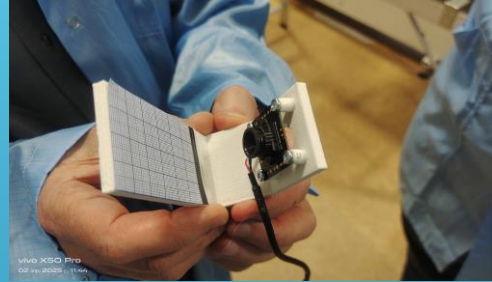
Test set up with UV laser



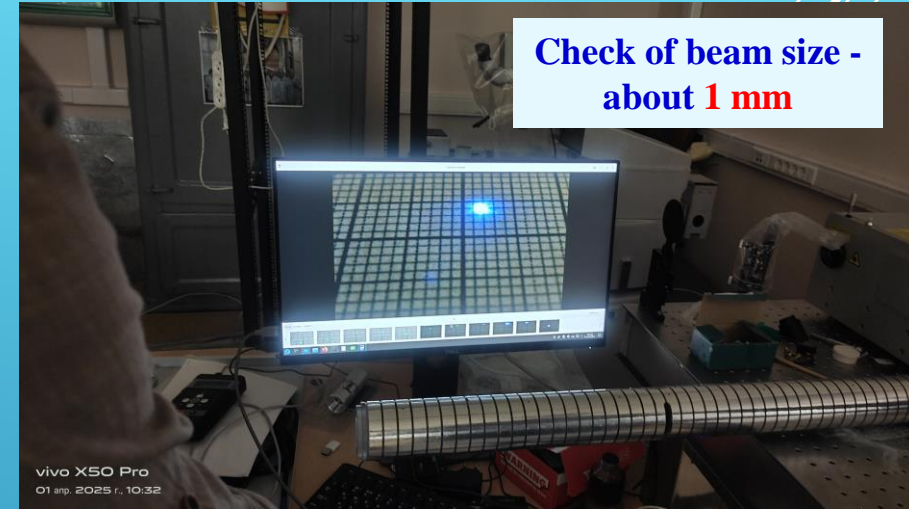
7 beams



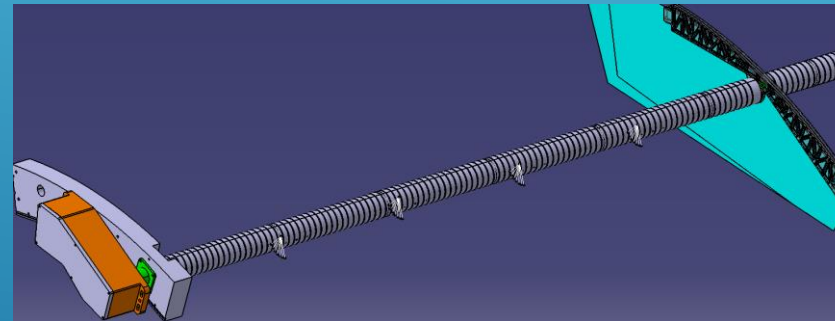
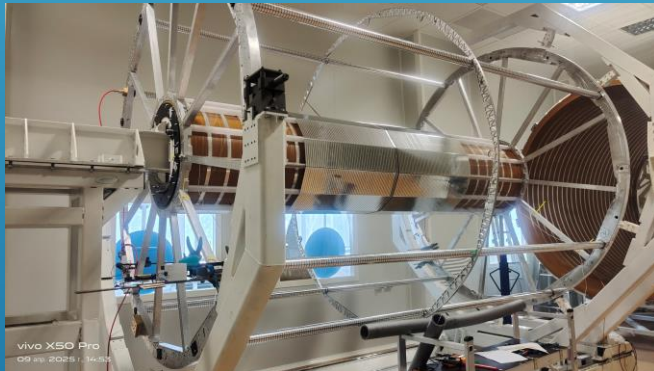
Video camera (MEPHI)



Check of beam size - about 1 mm



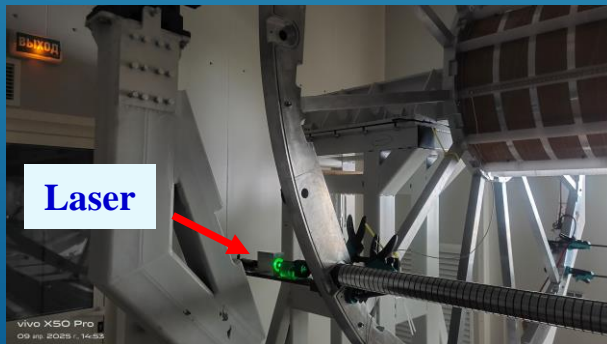
Test tube #7 with "green" laser



Micro-mirrors bundle



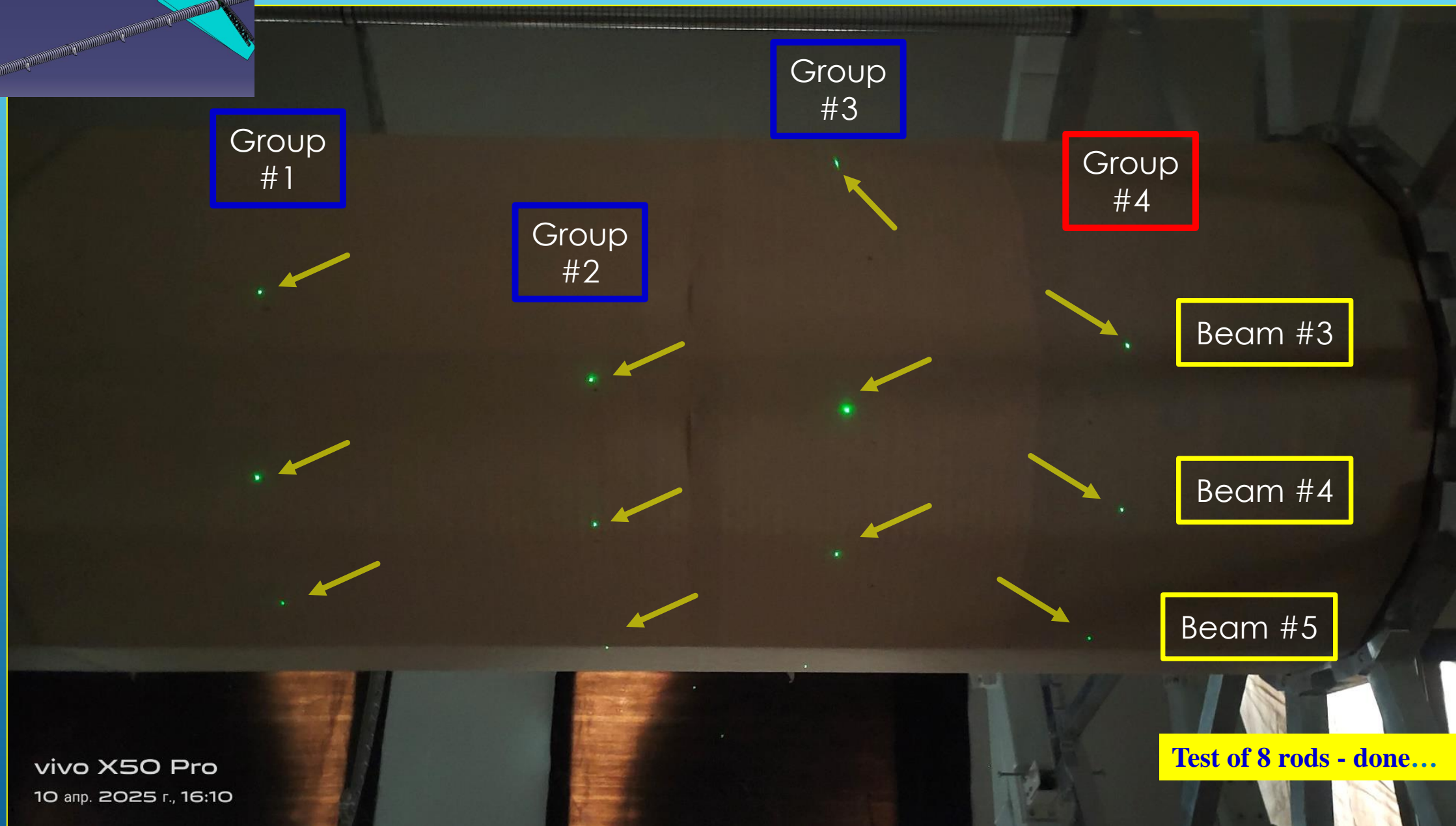
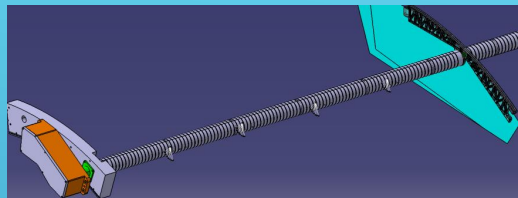
Laser



System improvements (MEPhi):

- add video cameras for check beams position
- add pico-actuators for mirrors tuning

TPC SUB-SYSTEMS: LASER CALIBRATION SYSTEM



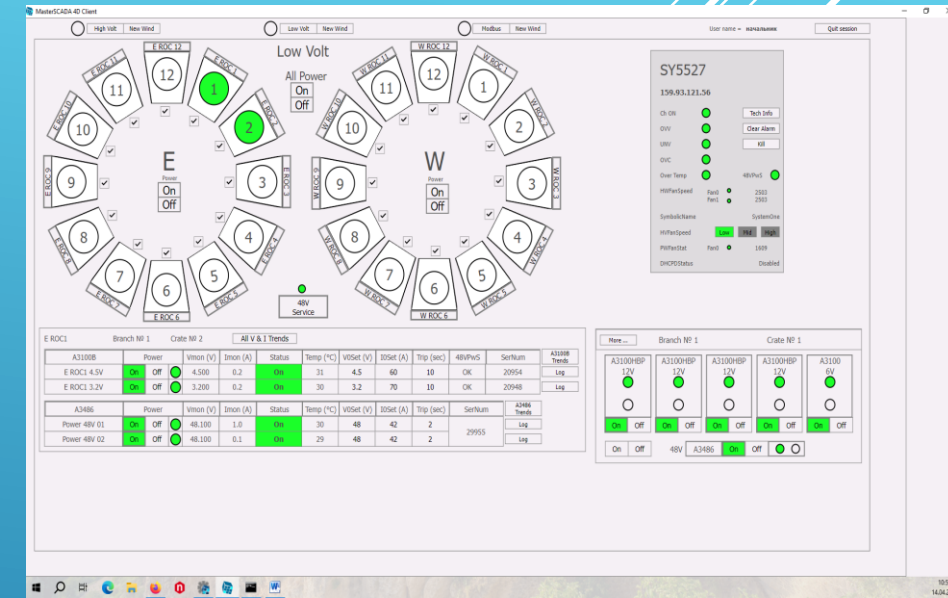
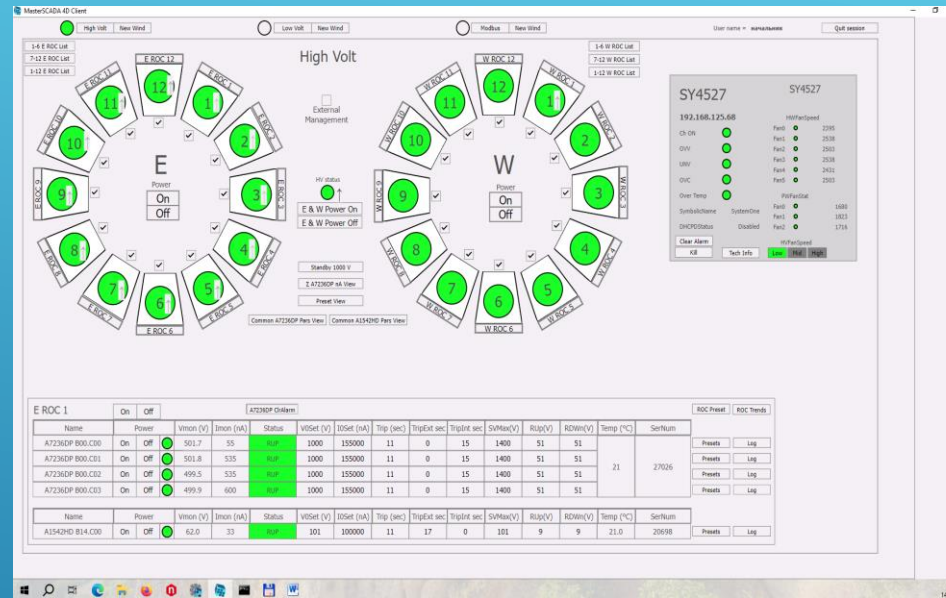
TPC SUB-SYSTEMS: SLOW CONTROL

CAEN LV test setup

Main window of LV+HV GUI based on MasterScada 4D

HV

LV

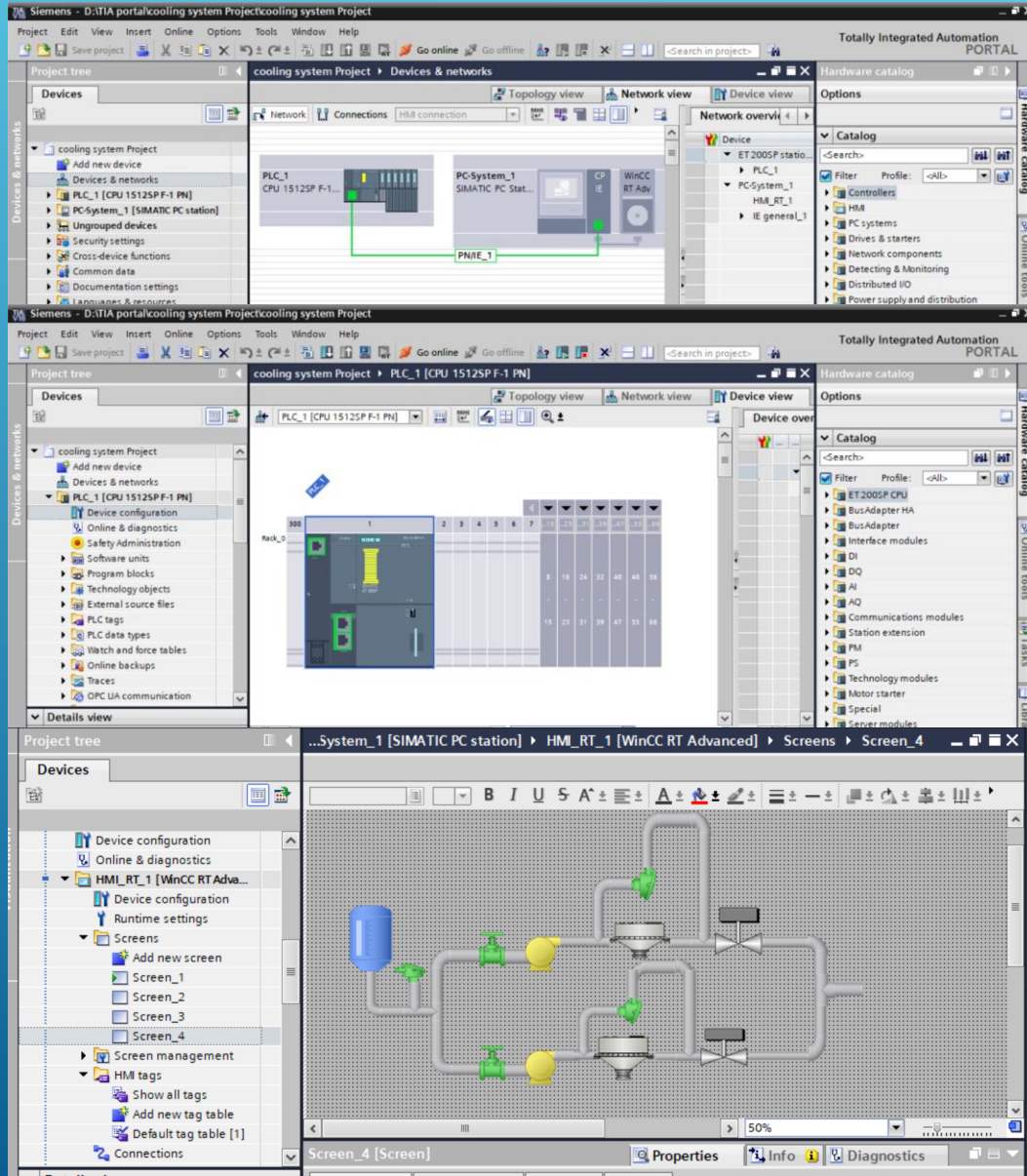


DATA transfer from MasterScada 4D to the DB POSTGRESQL16 – OK!

in progress ...

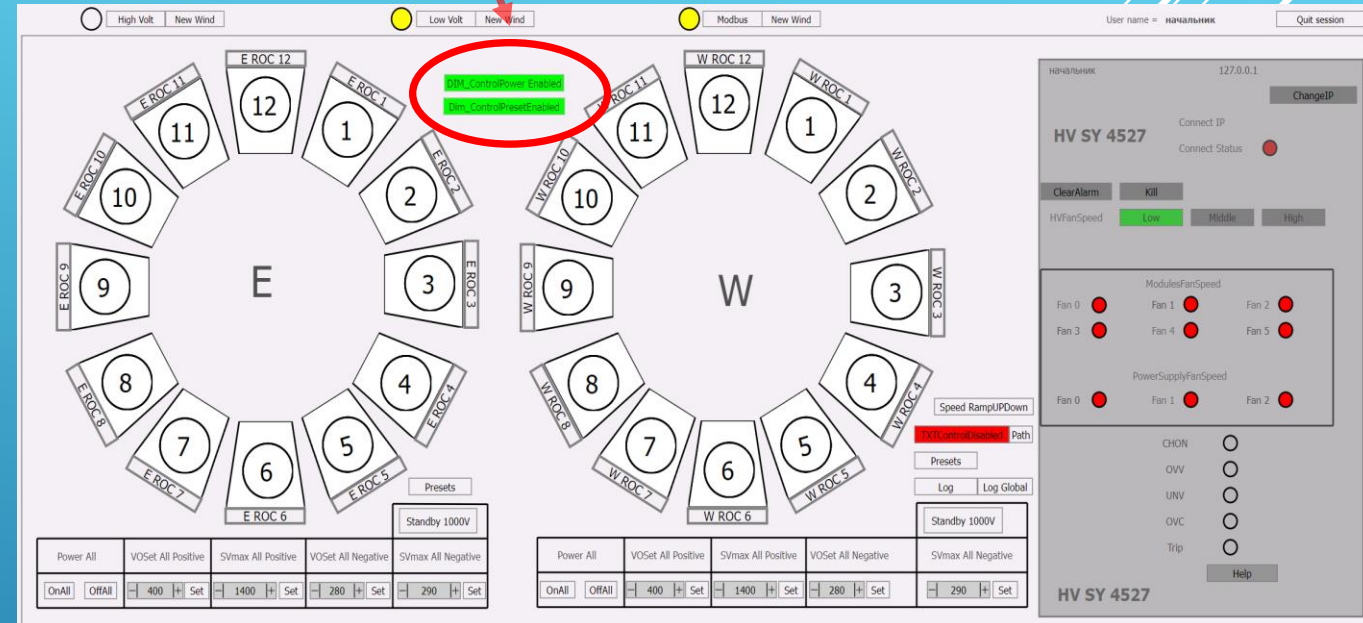
TPC SUB-SYSTEMS: TPC SLOW CONTROL => MPD DCS

GUI for cooling system

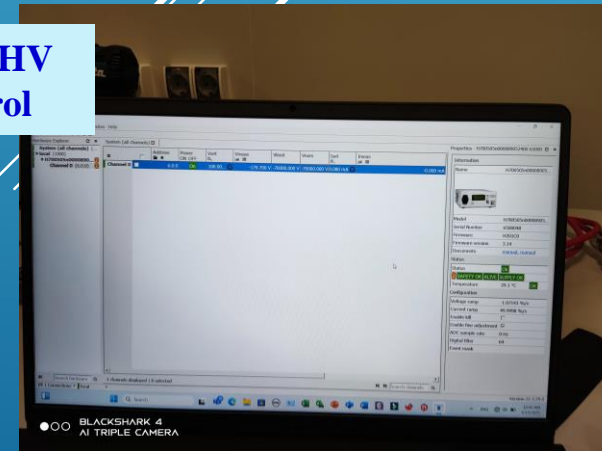


Connection with MPD DCS
(DIM protocol)

LV+HV



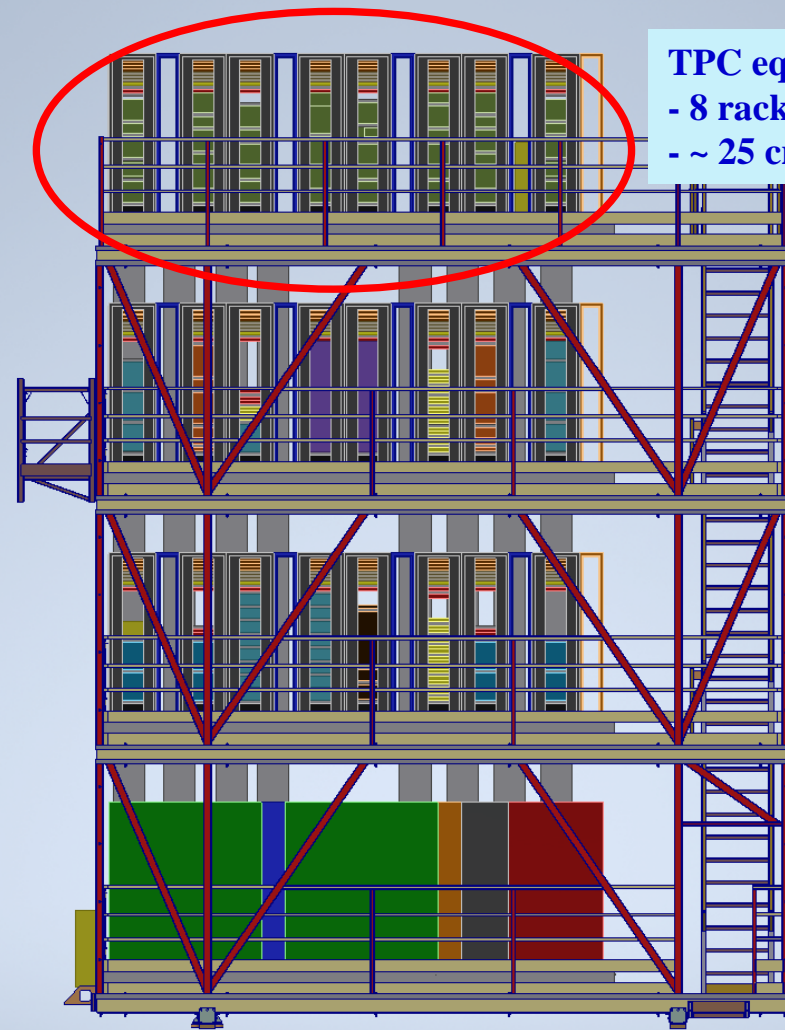
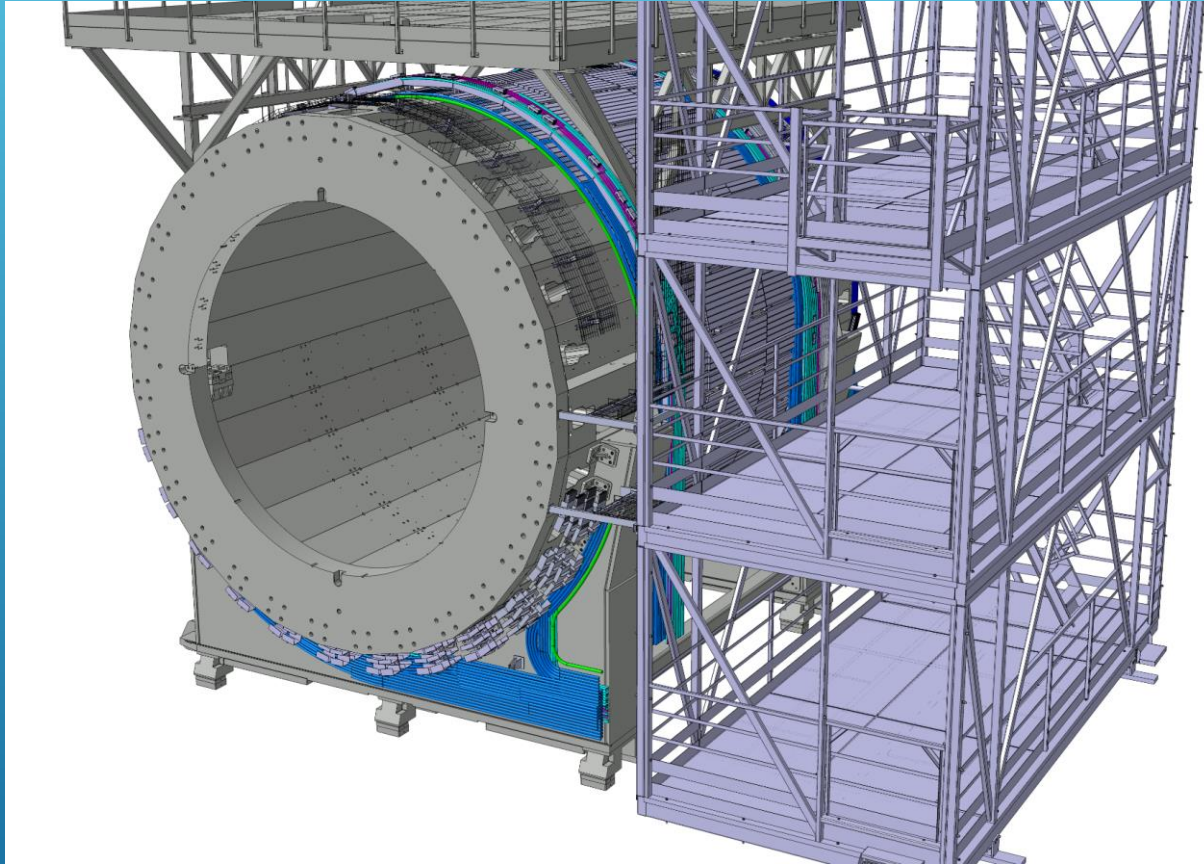
ISEG HV
control



in progress ...

INTEGRATION: “ELECTRONICS” PLATFORM (NORTH)

Common view



TPC equipment:
- 8 racks
- ~ 25 crates

Integration – in progress ...
Installation – Sept - Oct

TPC: PIPING AND CABLING

Integration ...

Mesh for
cables and pipes
fixation

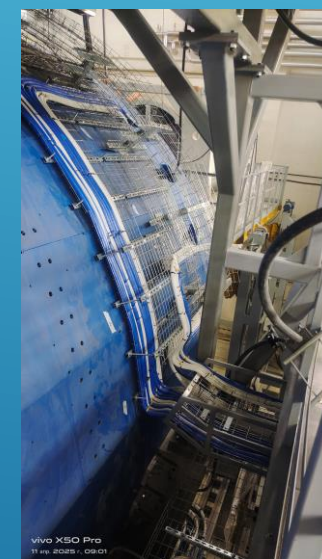
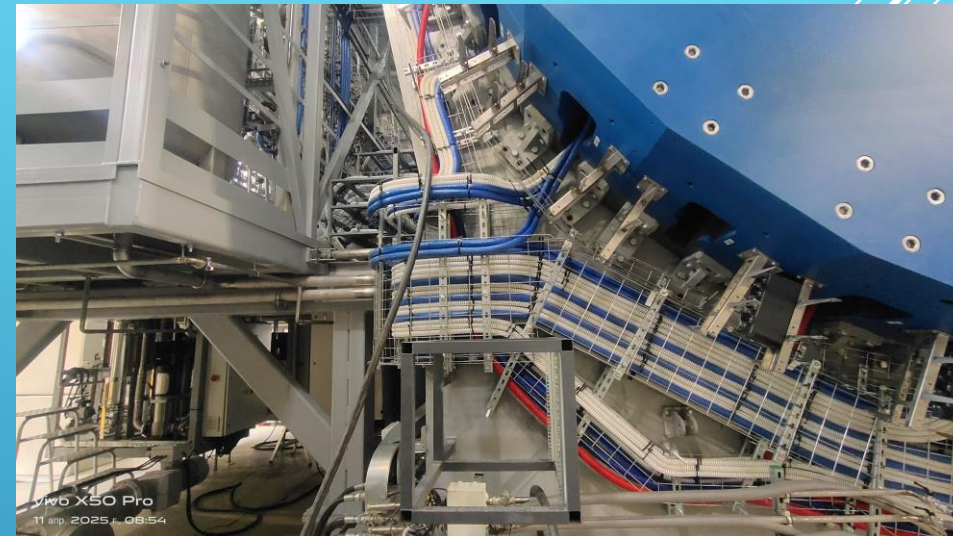
TPC

Beam pipe

Full set of parts –
in manufacture

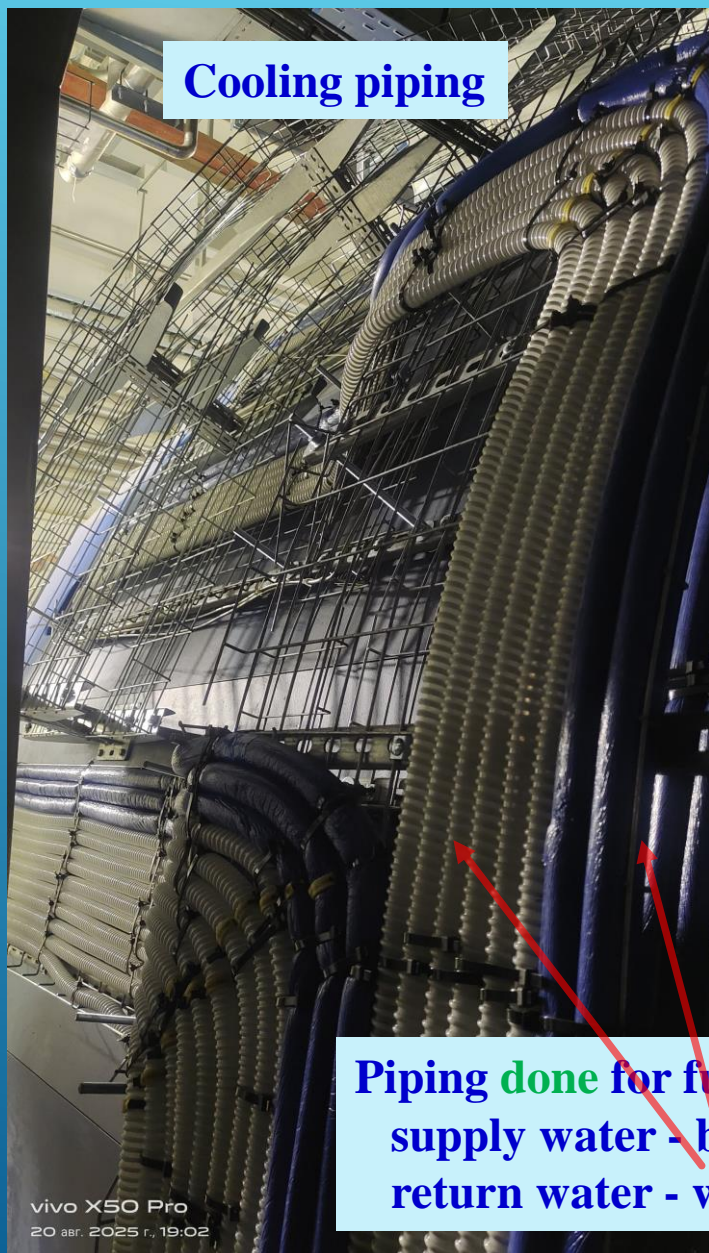
Mesh support design - done

TPC piping (water)

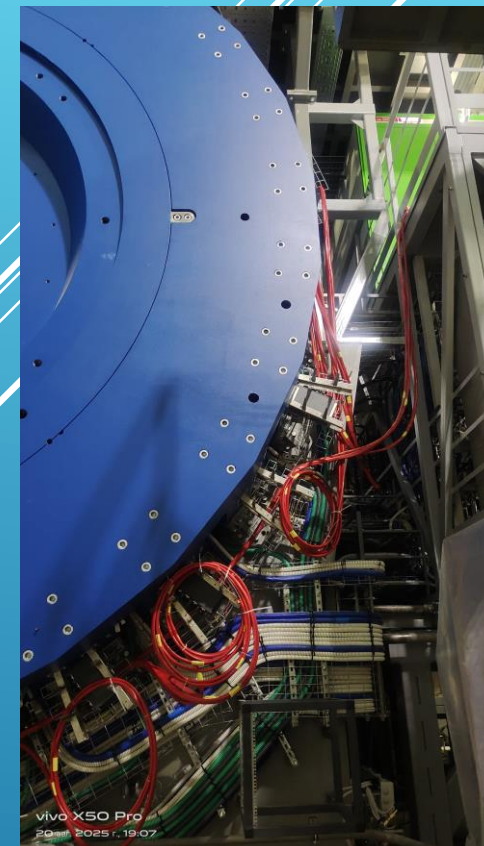
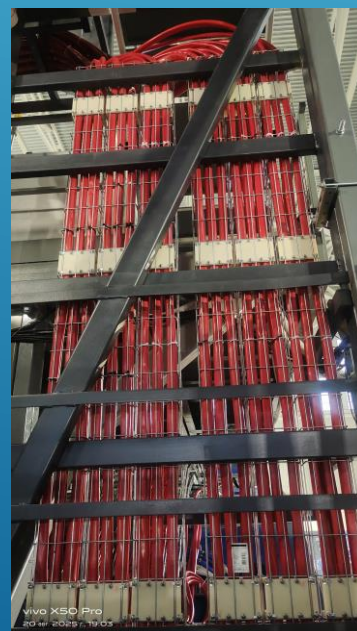
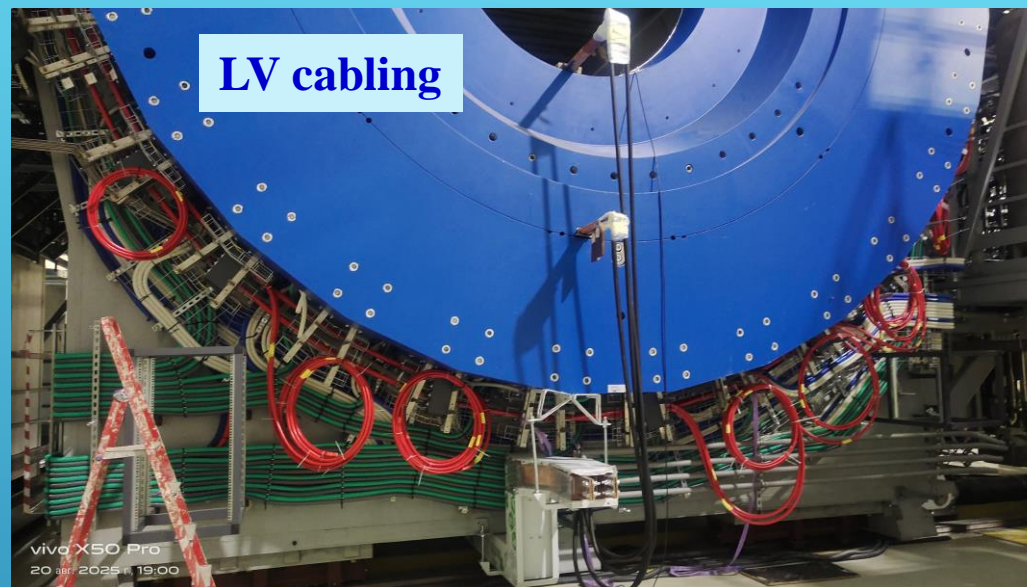


Piping and cabling - in progress ...

TPC: PIPING AND CABLING



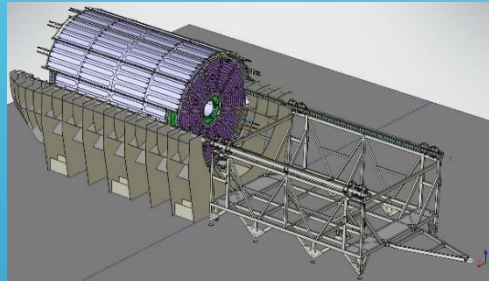
Piping **done** for full MPD:
supply water - blue
return water - write



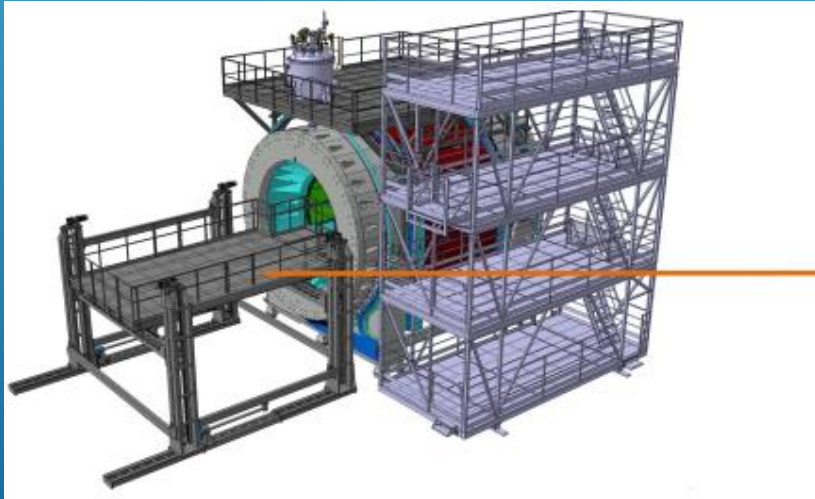
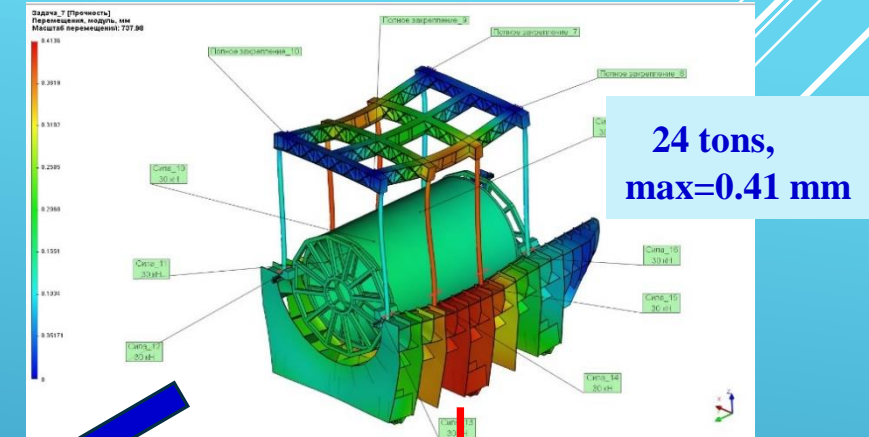
WEST – done
EAST – Sept 2025

TOOLING FOR INSTALLATION OF TPC TO MPD

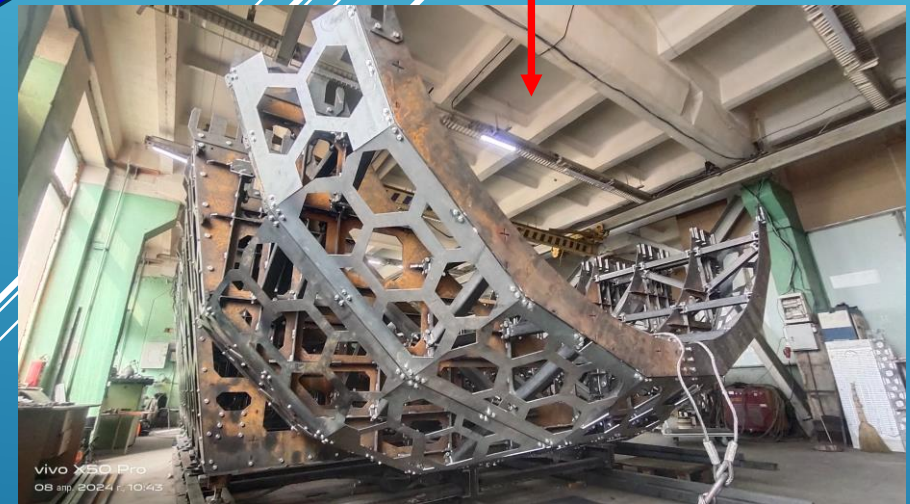
Bld. 217



Bld. 17 (MPD)



Lifting platform



Tooling for installation TPC to MPD tested and delivered to JINR

TPC installation to MPD – Nov 23 2025

STATUS AND TIME SCHEDULE

TPC sub-systems status:

TPC vessel assembling	in progress ...
ROC chambers (24+6 spare)	ready
FE electronics	100% manufactured (1488 FECs)
R/O controller v1.2	Test with ROC chamber – will be started soon => mass-production 30 pc
Gating grid system	ready, long term test at Minsk in progress
HV+LV systems (CAEN)	ready for start installation to MPD TPC racks on Electronics platform
Gas system	ready, waiting of gas piping at MPD building
Cooling system on TPC	in progress (all radiators and thermal sheets ready, TPC collectors manufacture - contracted)
TPC+ECAL cooling system	in progress (piping-done, cabling - in progress, assembling of automatics, software ...)
Laser system	in progress (8 TPC rods with mirrors assembled, integration to MPD - started)
Slow control system	in progress (LV +HV sub-systems based on OPS + MasterScada 4D ready, SC for rest TPC sub-systems – started)

TPC schedule:

TPC:	
TPC vessel assembled and tested	Sept 25 2025
ROC chambers installation	Oct 2025
TPC tests (with laser tracks and cosmic ray)	Nov 2025
TPC rails and installation tooling	
Rails installed to ECAL support structure	done (01/08/2024)
Tooling for installation TPC to MPD	delivered (end of 2024)
TPC+ECAL cooling systems (INP BSU, Minsk):	
Delivery to JINR	done (Sept 30 2024)
Systems assembling and start up	up to Nov 30 2025 (3 water vessels and 3 pump modules are installed and tested (Dec 2024))
Commissioning	Dec 2025
TPC installation to MPD	Nov 23 2025
Cabling	Dec 2025
MPD commissioning	Dec 2025

BELARUS CONTRIBUTION TO TPC

Mechanics («ARTMASH» and “KRAINA”, Minsk):

- MPD mockup 1:5
- TPC flanges (2 pc) + HV electrode (1 pc)
- service wheel (2pc)
- FE cooling radiators (30 sets)
- LVN9 cooling radiators (9 pc)
- tooling for installation TPC to MP: mockup 1:5 and serial
- TPC serial rails 6 meters (2 pc)

Electronics (INP BSU):

- LVN9 stabilization module (48 pc)
- burning test setup for tests of FE electronics (1 pc)
- setup for test FE cards (1 pc)
- test of FE cards (600 pc) – in progress
- system for anode signal measurements (96ch) – in progress
- gate system for ROC chamber (24ch)

TPC + ECAL cooling system (INP BSU - full responsibility)

- cooling setup for tests (2 pc)
- 3 serial systems - in progress

R&D (INP BSU,):

- ThGEM: tests and study
- DLC like protection coating from sparks for gas detectors
- DLC study: structures and long term stability
- metalize nuclear membrane like mesh for electrons and ions drift

MPD and SPD detectors grounding (Институт Энергетики БАН)

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Many Thanks!!!!

sorry if anybody forgotten

THANKS FOR ATTENTION